

SLTS221A-MARCH 2004-REVISED OCTOBER 2005

6-A NON-ISOLATED DDR/QDR MEMORY BUS TERMINATION MODULES

FEATURES

- V_{TT} Bus Termination Output (Output Tracks the System V_{BFF})
- 6 A Output Current (8 A Peak)
- 3.3-V, 5-V or 12-V Input Voltage
- **DDR and QDR Compatible**
- On/Off Inhibit (for V_{TT} Standby)
- Undervoltage Lockout
- Operating Temperature: -40°C to 85°C
- Efficiencies up to 88%
- **Output Overcurrent Protection (Non-Latching,** Auto-Reset)

- 50 W/in³ Power Density
- Safety Agency Approvals: UL/cUL60950, EN60950, VDE
- Point-of-Load Alliance (POLA[™]) Compatible



(22.1 mm x 12.57 mm)

DESCRIPTION

The PTHxx050Y are a series of ready-to-use switching regulator modules from Texas Instruments designed specifically for bus termination in DDR and QDR memory applications. Operating from either a 3.3-V, 5-V or 12-V input, the modules generate a V_{TT} output that will source or sink up to 6 A of current (8 A transient) to accurately track their V_{REF} input. V_{TT} is the required bus termination supply voltage, and V_{REF} is the reference voltage for the memory and chipset bus receiver comparators. V_{REF} is usually set to half the V_{DDO} power supply voltage.

Both the PTHxx050Y series employs an actively switched synchronous rectifier output to provide state-of-the-art stepdown switching conversion. The products are small in size (0.87 in × 0.5 in), and are an ideal choice where space, performance, and high efficiency are desired, along with the convenience of a ready-to-use module.

Operating features include an on/off inhibit and output over-current protection (source mode only). The on/off inhibit feature allows the V_{TT} bus to be turned off to save power in a standby mode of operation.

Package options include both throughhole and surface mount configurations.



STANDARD APPLICATION

CIN = Required Electrolytic Capacitor; 220μF (3.3 ± 5 V Input), 560 μF (12 V Input).

Co1 = Required Low-ESR Electrolyitic Capacitor; 470 μF (3.3 ± 5 V Input), 940 μF (12 V Input).

Co2 = Ceramic Capacitance for Response to a 3 A (+ 1.5 A) Load Transient; 200 µF (3.3 ± 5 V Input), 400 µF (12 V Input).

Con = Distributed hf-Ceramic Decoupling Capacitors for V_{TT} bus; as Recommended for DDR Memory Applications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. POLA is a trademark of Texas Instruments.

PTH03050Y PTH05050Y PTH12050Y

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TEXAS INSTRUMENTS www.ti.com

ORDERING INFORMATION

PTHXX050Y (Base Part Number)										
Input Voltage	Part Number ⁽¹⁾	DESCRIPTION	Pb – free and RoHS	Mechanical Package						
	PTH03050YAH	Horizontal T/H	Yes ⁽³⁾	EUU						
3.3 V	PTH03050YAS	Standard SMD	No ⁽⁴⁾	EUV						
	PTH03050YAZ	Optional SMD	Yes ⁽³⁾	EUV						
	PTH05050YAH	Horizontal T/H	Yes ⁽³⁾	EUU						
5 V	PTH05050YAS	Standard SMD	No ⁽⁴⁾	EUV						
	PTH05050YAZ	Optional SMD	Yes ⁽³⁾	EUV						
	PTH12050YAH	Horizontal T/H	Yes ⁽³⁾	EUU						
12 V	PTH12050YAS	Standard SMD	No ⁽⁴⁾	EUV						
	PTH12050YAZ	Optional SMD	Yes ⁽³⁾	EUV						

(1) Add *T* to end of part number for tape and reel on SMD packages only.

(1) Add 7 to end of part number for tape and reer on one packages only.
 (2) Reference the applicable package reference drawing for the dimensions and PC board layout.
 (3) Lead (Pb) –free option specifies Sn/Ag pin solder material.
 (4) Standard option specifies 63/37, Sn/Pb pin solder material.

ENVIRONMENTAL AND ABSOLUTE MAXIMUM RATINGS

voltages are with respect to GND

				UNIT
V_{REF}	Control input voltage	–0.3 V to V _i +0.3 V		
T _A	Operating temperature range	Over V _{IN} range	–40°C to 85°C ⁽¹⁾	
T _{wave}	Wave solder temperature	Surface temperature of module body or pins (5 seconds)	PTHXX050YAH	260°C ⁽²⁾
-	Solder reflow		PTHXX050YAS	235°C ⁽²⁾
I reflow	reflow temperature	Surface temperature of module body or pins	PTHXX050YAZ	260°C ⁽²⁾
Ts	Storage temperature			–40°C to 125°C
	Mechanical shock	Per Mil-STD-883D, Method 2002.3 1 msec, 1/2 Sine,	mounted	500 G
	Mechanical vibration	Mil-STD-883D, Method 2007.2 20-2000 Hz	20 G	
	Weight	2.9 grams		
	Flammability			

(1) For operation below 0°C the external capacitors m ust bave stable characteristics, use either a low ESR tantalum, Os-Con, or ceramic capacitor.

During soldering of package version, do not elevate peak temperature of the module, pins or internal components above the stated (2) maximum.

ELECTRICAL SPECIFICATIONS

 $T_A = 25^{\circ}C$; nominal V_{IN} ; $V_{REF} = 1.25 V$; C_{IN} , C_O1 , and $C_O2 =$ typical values; and $I_o = I_omax$ (unless otherwise stated)

	PARAMETER	TEST CON	MIN	TYP	MAX	UNIT		
	0.1.1		Continuous	0		±6 ⁽¹⁾	А	
lo	Output current	Over V _{REF} range			±8 ⁽²⁾	А		
			PTH03050Y	2.95		3.65	v	
V _{IN}	Input voltage range	Over I _O range	PTH05050Y	4.5		5.5		
			PTH12050Y	10.8		13.2		
ΔV_{REF}	Tracking range for V _{REF}			0.55		1.8	V	
VTT-VREF	Tracking tolerance to V _{REF}	Over line, load and temperature		-10		10	mV	
			PTH03050Y		88%			
η	Efficiency	$I_o = 4 A$	PTH05050Y		87%			
			PTH12050Y		84%			
V _r	V _o Ripple (pk-pk)	20 MHz bandwidth			20		mVpp	
l _o trip	Overcurrent threshold	Reset, followed by auto recovery			12		А	
t _{tr}		15 A/µs load step, from:	Recovery time		80		μsec	
V _{tr}	 Load transient response 	- 1.5 A to 1.5 A ⁽³⁾	V _O over/undershoot		25	40	mV	
			PTH03050Y		2.45	2.8	v	
		V _{IN} Increasing	PTH05050Y		4.3	4.45		
			PTH12050Y		9.5	10.4		
UVLO	Under-voltage lockout		PTH03050Y	2.0	2.40			
		V _{IN} Dncreasing	PTH05050Y	3.4	3.7		V	
			PTH12050Y	8.8	9			
V _{IH}	Inhibit control (pin 4) Input high voltage		Referenced to GND				V	
V _{IL}	Inhibit control (pin 4) Input low voltage						V	
I _{IL} inhibit	Inhibit control (pin 4) Input low curent	Pin to GND			130		μA	
l _{IN} inh	Input standby current	Inhibit control (pin 4) to GND			10		mA	
4	Switching frequency		PTH03050Y/PTH05050Y	550	600	650	kHz	
fs	Switching frequency	Over V_{IN} and I_O ranges	PTH12050Y	200	250	300	KE	
<u> </u>	External input consoitance		PTH03050Y/PTH05050Y	220 (5)			μF	
C _{IN}	External input capacitance		PTH12050Y	560 (5)			μr	
		Capacitance value: Nonceramic	PTH03050Y/PTH05050Y	470 ⁽³⁾		3300 (6)	μF	
			PTH12050Y	940 (3)		3300 ⁽⁶⁾		
Co ₁ , Co ₂	External output capacitance	Capacitanoo voluo: Coromia	PTH03050Y/PTH05050Y		200 (3)	300		
		Capacitance value: Ceramic	PTH12050Y		400 (3)	600	μF	
		Equiv. series resistance (non-cera	4 (7)			mΩ		
MTBF	Reliability	Per Bellcore TR-332 50 % stress,	T _A = 40°C, ground benign	6			10 ⁶ Hrs	

(1) Rating is conditional on the module being directly soldered to a 4-layer PCB with 1 oz. copper. See the SOA curves or contact the factory for appropriate derating. The PTH03050Y and PTH05050Y require no derating up to 85°C operating temperature and natural convection airflow.

(2) Up to 10 ms pulse period at 10% maximum duty.

(3) The minimum value of external output capacitance value ensures that VTT meets the specified transient performance requirements for the memory bus terminations. Lower values of capacitance may be possible when the *measured* peak change in output current is consistently less than 3 A.

(4) This control pin has an internal pull-up to the input voltage V_{IN}. If it is left open-circuit the module will operate when input power is applied. A small low-leakage (<100 nA) MOSFET is recommended for control. For further information, consult the related application note.</p>

(5) An input capacitor is required for proper operation. The capacitor must be rated for a minimum of 300 mA rms (750 mA rms for 12-V input) of ripple current.

(6) This is the calculated maximum. The minimum ESR limitation will often result in a lower value. Consult the application notes for further guidance.

(7) This is the typcial ESR for all the electrolytic (non-ceramic) output capacitance. Use 8 mΩ as the minimum when using max-ESR values to calculate.



Terminal Functions

TERMINAL		DESCRIPTION						
NAME	NO.	DESCRIPTION						
V _{IN}	3	The positive input voltage power node to the module, which is referenced to common GND.						
GND	1	This is the common ground connection for the V_{IN} and V_{TT} power connections. It is also the 0-VDC reference for the control inputs.						
V _{REF}	2	The module senses the voltage at this input to regulate the output voltage, V_{TT} . The voltage at V_{REF} is also the reference voltage for the system bus receiver comparators. It is normally set to precisely half the bus driver supply voltage (V_{DDQ} + 2), using a resistor divider. The Thevenin impedance of the network driving the V_{REF} pin should not exceed 500 Ω . See the Typical DDR Application Diagram in the Application Information section for reference.						
V _{TT}	6	This is the regulated power output from the module with respect to the GND node, and the tracking termination supply for the application data and address buses. It is precisely regulated to the voltage applied to the module's V_{REF} input, and is active active about 20 ms after a valid input source is applied to the module. Once active it will track the voltage applied at V_{REF} .						
Inhibit	4	The Inhibit pin is an open-collector/drain negative logic input that is referenced to GND. Applying a low-level ground signal to this input turns off the output voltage, V_{TT} . Although the module is inhibited, a voltage, V_{DDQ} will be present at the output terminals, fed through the DDR memory. When the Inhibit is active, the input current drawn by the regulator is significantly reduced. If the Inhibit pin is left open circuit, the module will produce an output whenever a valid input source is applied. See the Typical DDR Application Diagram in the Application Information section for reference.						
N/C	5	No Connection						



TYPICAL CHARACTERISTICS (V_{REF} =1.25 V)⁽¹⁾⁽²⁾



- (1) The electrical characteristic data has been developed from actual products tested at 25°C. This data is considered typical for the converter. Applies to Figure 1, Figure 2, and Figure 3.
- (2) The temperature derating curves represent the conditions at which internal components are at or below the manufacturer's maximum operating temperatures. Derating limits apply to modules soldered directly to a 4 mm x 4 mm double-sided PCB with 1 oz. copper. For surface mount packages (AS and AZ suffix), multiple vias (plated through holes) are required to add thermal paths around the power pins. Please refer to the mechanical specification for more information. Applies to Figure 4, and Figure 5.



APPLICATION INFORMATION

Typical DDR Application Diagram



CAPACITOR RECOMMENDATIONS FOR THE PTH03050Y & PTH05050Y DDR POWER MODULES (3.3-V/5-V OPTION)

Input Capacitor

The recommended input capacitor(s) is determined by the 220 μ F minimum capacitance and 500 mArms minimum ripple current rating.

Ripple current and less than 100 m Ω equivalent series resistance (ESR) values are the major considerations, along with temperature, when designing with different types of capacitors. Unlike polymer tantalum, regular tantalum capacitors have a recommended minimum voltage rating of 2 × (maximum DC voltage + AC ripple). This is standard practice to insure reliability.

For improved ripple reduction on the input bus, ceramic capacitors may be substituted for electrolytic types using the minimum required capacitance.

Output Capacitors

For applications with load transients (sudden changes in load current), regulator response will benefit from external output capacitance. The recommended output capacitance of 470 μ F will allow the module to meet its transient response specification (see Electrical Specifications table). For most applications, a high quality computer-grade aluminum electrolytic capacitor is adequate. These capacitors provide decoupling over the frequency range, 2 kHz to 150 kHz, and are suitable when ambient temperatures are above 0°C. For operation below 0°C tantalum, ceramic or Os-Con type capacitors are recommended. When using one or more non-ceramic capacitors, the calculated equivalent ESR should be no lower than 4 m Ω (8 m Ω using the manufacturer's maximum ESR for a single capacitor). A list of preferred low-ESR type capacitors are identified in Table 1.

APPLICATION INFORMATION (continued)

Ceramic Capacitors (Recommended)

Above 150 kHz the performance of aluminum electrolytic capacitors becomes less effective. To further improve the reflected input ripple current or the output transient response. Multilayer ceramic capacitors have very low ESR and their resonant frequency higher than the bandwidth of the regulator. They can be used to reduce the reflected ripple current at the input as well as improve the transient response of the output. When used on the output their combined ESR is not critical as long as the total value of ceramic capacitance does not exceed $300 \ \mu\text{F}$. Also, to prevent the formation of local resonances, do not place more than five identical ceramic capacitors in parallel with values of $10 \ \mu\text{F}$ or greater.

Tantalum Capacitors

Tantalum type capacitors can be used at both the input and output, and are recommended for applications where the ambient operating temperature can be less than 0°C. The AVX TPS, Sprague 593D/594/595 and Kemet T495/T510 capacitor series are suggested over many other tantalum types due to their higher rated surge, power dissipation, and ripple current capability. As a caution many general purpose tantalum capacitors have considerably higher ESR, reduced power dissipation and lower ripple current capability. These capacitors are also less reliable when determining their power dissipation and surge current rating. Tantalum capacitors that do not have a stated ESR or surge current rating are not recommended for power applications.

When specifying Os-Con and polymer tantalum capacitors for the output, the minimum ESR limit will be encountered well before the maximum capacitance value is reached.

Capacitor Table

Table 1 identifies the characteristics of capacitors from a number of vendors with acceptable ESR and ripple current (rms) ratings. The recommended number of capacitors required at both the input and output buses is identified for each capacitor type.

This is not an extensive capacitor list. Capacitors from other vendors are available with comparable specifications. Those listed are for guidance. The RMS ripple current rating and ESR (at 100 kHz) are critical parameters necessary to insure both optimum regulator performance and long capacitor life.

			Capacitor Ch	Quantity		Vendor Part Number		
Capacitor Vendor, Type/Series (Style)	Valua		Max ESR at 100 kHz (Ω)	100 kHz Current at 85°C				Input Output Bus Bus
Panasonic, Aluminum								
FC (Radial)	10	470	0.117	555	8×10	1	1	EEUFC1A471
FK (SMD)	25	470	0.080	850	10×10.2	1	1	EEVFK1E471P
FC (SMD)	16	470	0.150	670	10×10.2	1	1	EEVFC1C471P
United Chemi-Con								
PXA, Poly-Aluminum (SMD)	6.3	470	0.020	>4100	10×7.7	1	≤2	PXA6.3VC471MJ80TP
PS, Poly-Aluminum (Radial)	6.3	390	0.012	4770	8×11.5	1	≤1 ⁽²⁾	6PS390MH11
PSA, Poly-Aluminum (Radial)	10	470	0.008	5650	8×11,5	1	≤1	PSA10VB470MJ11
LXZ, Aluminum (Radial)	16	470	0.090	760	10×12.5	1	1	LXZ16VB471M10X12LL
Panasonic, Poly-Aluminum S/SE (SMD)	6.3	180	0.005	4000	7.3×4.3×4.2	2	N/R ⁽³⁾	EEFSE0J181R

Table 1. Input/Output Capacitors⁽¹⁾

(1) Capacitor Supplier Verification

Please verify availability of capacitors identified in this table. Capacitor suppliers may recommend alternative part numbers because of limited availability or obsolete products. In some instances, the capacitor product life cycle may be in decline and have short-term consideration for obsolescence.

RoHS, Lead-free and Material Details

Please consult capacitor suppliers regarding material composition, RoHS status, lead-free status, and manufacturing process requirements. Component designators or part number deviations can occur when material composition or soldering requirements are updated.

(2) The total capacitance can be slightly lower than recommended minimum, but is acceptable based on the combined ripple current rating.

(3) This capacitor is not recommended for the V_O bus. The capacitor ESR is below the specified minimum for non-ceramic capacitor.

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APPLICATION INFORMATION (continued)

			Capacitor Ch	Qu	antity				
Capacitor Vendor, Type/Series (Style)	Working Voltage (V)	Value (μF)	Max ESR at 100 kHz (Ω)	Max Ripple Current at 85°C (Irms) (mA)	Physical Size (mm)	Input Bus	Output Bus	Vendor Part Number	
Nichicon Aluminum									
WG (SMD)	10	470	0.150	670	10×10	1	1	UWG1A471MNR1GS	
HD (Radial)	10	470	0.072	760	8×11.5	1	1	UHD1A471MPR	
PM (Radial)	10	470	0.120	600	10×12.5	1	1	UPM1A471MPH6	
Sanyo									
SP, Os-con (Radial)	10	470	0.015	4500	10×10.5	1	≤2	10SP470M	
SVPA (SMD)	6.3	470	0.020	>4100	7,9×10	1	≤2	6SVPA470M	
TPE, Poscap (SMD)	6.3	220	0.025	2400	7.3×4.3	1	≤3	6TPE220ML	
AVX, Tantalum	10	330	0.045	1723	7.3L ×5.7W	1	≤5	TPSE337M010R0045	
TPS (SMD)	10	330	0.060	1826	×4.1H	1	≤5	TPSV337M010R0060	
Kemet, Poly-Tantalum									
T520 (SMD)	10	330	0.040	1800	4.3W ×7.3L ×4.0H	1	≤5	T520X337M010ASE045	
T530 (SMD)	10	330	0.010	>5000		1	≤1	T530X337M010ASE010	
Vishay-Sprague									
595D, Tantalum (SMD)	10	330	0.100	1040	7.2L×6W ×4.1H	1	≤5	595D377x0010D2T	
594D, Tantalum (SMD)	10	330	0.045	2360	×4.1H 10x10.5	1	≤5	594D337X0016R2T	
94SVP, Poly-Aluminum (Radial)	6.3	330	0.025	3500		1	≤3	94SA337X06R3FBP	
Kemet, Ceramic X5R (SMD)	16	10	0.002	-	1210 /3225	1	≤5	C1210C106M4PAC	
	6.3	47	0.002		3225 mm	1	≤5	C1210C476K9PAC	
Murata, Ceramic X5R (SMD)	6.3	100	0.002	-	3225 mm	1 ⁽⁴⁾	≤3	GRM32ER60J107M	
	6.3	47	0.002		3225 mm	1 (4)	≤5	GRM32ER60J476M	
	16	22	0.002			1 ⁽⁴⁾	≤5	GRM32ER61C226K	
	16	10	0.002			1 ⁽⁴⁾	≤5	GRM32DR61C106K	
TDK, Ceramic X5R (SMD)	6.3	100	0.002	-	3225 mm	1 (4)	≤3	C3225X5R0J107MT	
	6.3	47	0.002		3225 mm	1 ⁽⁴⁾	≤5	C3225X5R0J476MT	
	16	22	0.002			1 (4)	≤5	C3225X5R1C226MT	
	16	10	0.002			1 (4)	≤5	C3225X5R1C106MT	

(4) A ceramic capacitor can be used to compliment electrolytic types at the input to further reduce high-frequency ripple current.

Designing for Very Fast Load Transients

The transient response of the DC/DC converter has been characterized using a load transient with a di/dt of 1 A/ μ s. The typical voltage deviation for this load transient is given in the data sheet specification table using the optional value of output capacitance. As the di/dt of a transient is increased, the response of a converter's regulation circuit ultimately depends on its output capacitor decoupling network. This is an inherent limitation with any DC/DC converter once the speed of the transient exceeds its bandwidth capability. If the target application specifies a higher di/dt or lower voltage deviation, the requirement can only be met with additional output capacitor decoupling. In these cases special attention must be paid to the type, value and ESR of the capacitors selected.

If the transient performance requirements exceed that specified in the data sheet, or the total amount of load capacitance is above 3300 μ F, the selection of output capacitors becomes more important.

CAPACITOR RECOMMENDATIONS FOR THE PTH12050Y DDR POWER MODULES PTH12050Y (12-V OPTION)

Input Capacitor

The recommended input capacitance is determined by the 560 μ F minimum capacitance and 750 mArms minimum ripple current rating. A \geq 10- μ F X5R/X7R ceramic capacitor can be added to reduce the reflected input ripple current. The ceramic capacitor should be located between the input electrolytic and the module.

Ripple current, less than 100 m Ω equivalent series resistance (ESR) and temperature, are major considerations when selecting input capacitors. Unlike polymer-tantalum capacitors, regular tantalum capacitors have a recommended minimum voltage rating of 2 × (max. dc voltage + ac ripple). No tantalum capacitors were found with sufficient voltage rating to meet this requirement. At temperatures below 0°C, the ESR of aluminum electrolytic capacitors increases. For these applications, Os-Con, polymer-tantalum, and polymer-aluminum types should be considered.

Output Capacitors

For applications with load transients (sudden changes in load current), regulator response will benefit from external output capacitance. The recommended minimum output capacitance of 940 μ F will allow the module to meet its transient response specification (see Electrical Specifications table). For most applications, a high quality computer-grade aluminum electrolytic capacitor is adequate. These capacitors provide decoupling over the frequency range, 2 kHz to 150 kHz, and are suitable when ambient temperatures are above 0°C. For operation below 0°C tantalum, ceramic or Os-Con type capacitors are recommended. When using one or more non-ceramic capacitors, the calculated equivalent ESR should be no lower than 4 m Ω (8 m Ω using the manufacturer's maximum ESR for a single capacitor)

A list of preferred low-ESR type capacitors are identified in Table 2.

In addition to electrolytic capacitance, adding a $10-\mu$ F to $22-\mu$ F X5R/X7R ceramic capacitor to the output reduces the output ripple voltage and improves the regulator's transient response. The measurement of both the output ripple and transient response is also best achieved across a $10-\mu$ F ceramic capacitor.

Ceramic Capacitors

Above 150 kHz, the performance of aluminum electrolytic capacitors is less effective. Multilayer ceramic capacitors have a low ESR and a resonant frequency higher than the bandwidth of the regulator. They can be used to reduce the reflected ripple current at the input, and improve the transient response of the output. When used on the output, their combined ESR is not critical as long as the total value of ceramic capacitance does not exceed 300 μ F. Also, to prevent the formation of local resonances, do not place more than five identical ceramic capacitors in parallel with values of 10 μ F or greater.

Tantalum Capacitors

Tantalum type capacitors are most suited for use on the output bus, and are recommended for applications where the ambient operating temperature can be less than 0°C. The AVX TPS, Sprague 593D/594/595, and Kemet T495/T510 capacitor series are suggested over other tantalum types due to their higher rated surge, power dissipation, and ripple current capability. As a caution, many general-purpose tantalum capacitors have considerably higher ESR, reduced power dissipation, and lower ripple current capability. These capacitors are also less reliable as they have lower power dissipation and surge current ratings. Tantalum capacitors that do not have a stated ESR or surge current rating are not recommended for power applications.

When specifying Os-con and polymer tantalum capacitors for the output, the minimum ESR limit is encountered well before the maximum capacitance value is reached.

Capacitor Table

Table 2 identifies the characteristics of capacitors from a number of vendors with acceptable ESR and ripple current (rms) ratings. The recommended number of capacitors required at both the input and output buses is identified for each capacitor type.

Note: This is not an extensive capacitor list. Capacitors from other vendors are available with comparable specifications. Those listed are for guidance. The RMS ripple current rating and ESR (at 100 kHz) are critical parameters necessary to insure both optimum regulator performance and long capacitor life.

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Table 2. Input/Output Capacitors⁽¹⁾

			Capacitor	Characteristic	Qua	ntity		
Capacitor Vendor, Type/Series (Style)	Working Voltage (V)	Value (µF)	Max ESR at 100 kHz (Ω)	Max Ripple Current at 85°C (Irms) (mA)	Physical Size (mm)	Input Bus	Output Bus	Vendor Number
Panasonic, Aluminum FC Radial	25	560	0.065	1205	12,5 × 15	1	1	EEUFC1E561S
FK (SMD)	16	680	0.080	850	10 × 10,2	1	2	EEVFK1C681P
United Chemi-Con								
PXA, Poly-Aliminum (SMD)	16	330	0.014	5050	10 × 12,5	2	≤2	PXA16VC331MJ12TP
PS, Poly-Aluminum (Radial)	16	330	0.0014	5050	10 × 12,5	2	≤2	16PS330MJ12
LXZ, Aluminum (Radial)	16	680	0.068	1050	10 × 16	1	1	LXZ16VB681M10X16LL
Nichicon Aluminum	25	560	0.060	1060	12,5 × 15	1	1	UPM1E561MHH6
PM (Radial)	16	680	0.038	1430	10 × 16	1	2	UHD1C681MHR
HD (Radial)	35	560	0.048	1360	16 × 15	1	1	UPM1V561MHH6
Panasonic, Poly-Alum S/SE (SMD)	6.3	180	0.005	4000	7,3 imes 4,3 imes 4,2	N/R ⁽²⁾	≤1	EEFSE0J181R
Sanyo								
TPE, ps-Ccap (SMD)	10	330	0.025	3000	7,3 L × 5,7 W	N/R ⁽²⁾	≤3	10TPE330M
SEPC Os-con (Radial)	16	470	0.010	>6100	10 × 13	1 ⁽³⁾	≤1	16SEPC470M
SVP, Os-con (SMD)	16	330	0.016	4700	11 × 12	2	≤2	16SVP330M
SVPC Os-con (SMD)	4	1200	0.010	4700	8 × 11,9	N/R ⁽²⁾	≤1	4SVPC1200M
AVX, Tantalum TPS (SMD)	10	470	0.045	>1723	7,3 × 5,7 × 4,1	N/R ⁽²⁾	≤5	TPSE477M019R0045
	10	330	0.045	>1723		N/R ⁽²⁾	≤5	TPSE337M019R0045
Kemet								
T520, Poly-Tantalum (SMD)	6.3	470	0.040	1800		N/R ⁽²⁾	≤5	T520X477M006ASE040
T530, Tantalum/Organic	4	680	0.010	>5100	$4,3 \times 7,3 \times 4$	N/R ⁽²⁾	≤1	T530X687M004ASE010
T530, Tantalum/Organic	6.3	470	0.010	5200		N/R ⁽²⁾	≤1	T530X477M006ASE010
Vishay-Sprague								
594D, Tantalum (SMD)	10	470	0.100	1440	7,2 × 6 × 4,1	N/R ⁽²⁾	≤5	595D477X0010R2T
94SVP, Os-con (SMD)	16	330	0.017	>4500	10 × 12,7	2	≤2	94SVP337X0016F12
94SA, Organic (Radial)	16	1000	0.015	>9700	16 × 25	1	≤2	94SA108X0016HBP
Kemet, Ceramic X5R (SMD)	16	10	0.002		3225 mm	1 (4)	≤5	C1210C106M4PAC
	6.3	47	0.002		3225 mm	N/R ⁽²⁾	≤5	C1210C476K9PAC
Murata, Ceramic X5R (SMD)	6.3	100	0.002		3225 mm	N/R ⁽²⁾	≤3	GRM32ER60J107M
	6.3	47			3225 mm	N/R ⁽²⁾	≤5	GRM32ER60J476M
	16	22				1 ⁽⁴⁾	≤5	GRM32ER61C226K
	16	10				1 (4)	≤5	GRM32DR61C106K
TDK, Ceramic X5R (SMD)	6.3	100	0.002		3225 mm	N/R ⁽²⁾	≤3	C3225X5R0J107MT
· · ·	6.3	47			3225 mm	N/R ⁽²⁾	≤5	C3225X5R0J476MT
	16	22				1 ⁽⁴⁾	≤5	C3225X5R1C226MT
	16	10				1 (4)	≤5	C3225X5R1C106MT

(1) Capacitor Supplier Verification

Please verify availability of capacitors identified in this table. Capacitor suppliers may recommend alternative part numbers because of limited availability or obsolete products. In some instances, the capacitor product life cycle may be in decline and have short-term consideration for obsolescence.

RoHS, Lead-free and Material Details

Please consult capacitor suppliers regarding material composition, RoHS status, lead-free status, and manufacturing process requirements. Component designators or part number deviations can occur when material composition or soldering requirements are updated.

(2) $\dot{N/R}$ – Not recommended. The capacitor voltage rating does not meet the minimum operating limits.

(3) A total capacitance of 470 μ F is acceptable based on the combined ripple current rating.

(4) Ceramic capacitors are recommended to complement electrolytic types at the input and to reduce high-frequency ripple current.

Designing for Very Fast Load Transients

The transient response of the DC/DC converter has been characterized using a load transient with a di/dt of 1 A/ μ s. The typical voltage deviation for this load transient is given in the data sheet specification table using the optional value of output capacitance. As the di/dt of a transient is increased, the response of a converter's regulation circuit ultimately depends on its output capacitor decoupling network. This is an inherent limitation with any DC/DC converter once the speed of the transient exceeds its bandwidth capability. If the target application specifies a higher di/dt or lower voltage deviation, the requirement can only be met with additional output capacitor decoupling. In these cases special attention must be paid to the type, value and ESR of the capacitors selected.

If the transient performance requirements exceed that specified in the data sheet, or the total amount of load capacitance is above 3300 μ F, the selection of output capacitors becomes more important.

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PTH03050Y PTH05050Y PTH12050Y

PICKUP AREA SEE NDTE

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TRAY SPECIFICATION



PTXXXX5X	″A″	″B″	"X"	"Y"					
PTH03050/05050	29.90	19.62	33.12	22.86					
PTH12050	29.35	20.39	33.12	22.86					
PTN04050A	25.29	23.88							
PTN04050C	25.32	19.88							
ALL DIMENSIONS ARE IN MILLIMETER.									

DEVICES/TRAY 56



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
PTH03050YAH	ACTIVE	Through- Hole Module	EUU	6	56	RoHS Exempt & Green	SN	N / A for Pkg Type	-40 to 85		Samples
PTH03050YAS	ACTIVE	Surface Mount Module	EUV	6	56	Non-RoHS & Green	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH03050YAST	ACTIVE	Surface Mount Module	EUV	6	250	Non-RoHS & Green	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH03050YAZ	ACTIVE	Surface Mount Module	EUV	6	56	RoHS (In Work) & Green	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples
PTH05050YAH	ACTIVE	Through- Hole Module	EUU	6	56	RoHS (In Work) & Green (In Work)	SN	N / A for Pkg Type	-40 to 85		Samples
PTH05050YAS	ACTIVE	Surface Mount Module	EUV	6	56	Non-RoHS & Green	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH05050YAZ	ACTIVE	Surface Mount Module	EUV	6	56	RoHS (In Work) & Green	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples
PTH05050YAZT	ACTIVE	Surface Mount Module	EUV	6	250	RoHS (In Work) & Green	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples
PTH12050YAH	ACTIVE	Through- Hole Module	EUU	6	56	RoHS Exempt & Green (In Work)	SN	N / A for Pkg Type	-40 to 85		Samples
PTH12050YAS	ACTIVE	Surface Mount Module	EUV	6	56	Non-RoHS & Green (In Work)	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH12050YAST	ACTIVE	Surface Mount Module	EUV	6	250	Non-RoHS & Green (In Work)	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH12050YAZ	ACTIVE	Surface Mount Module	EUV	6	56	RoHS (In Work) & Green (In Work)	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples
PTH12050YAZT	ACTIVE	Surface Mount Module	EUV	6	250	RoHS (In Work) & Green (In Work)	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.





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LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available. OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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EUU (R-PDSS-T6)

DOUBLE SIDED MODULE



- Β. This drawing is subject to change without notice.
 - C. 2 place decimals are ± 0.030 (± 0.76 mm).
 - D. 3 place decimals are $\pm 0.010 (\pm 0.25 \text{ mm})$.
 - E. Recommended keep out area for user components.
- - G. All pins: Material Copper Alloy
 - Finish Tin (100%) over Nickel plate



EUV (R-PDSS-B6)

DOUBLE SIDED MODULE



NOTES:

- Α. All linear dimensions are in inches (mm). Β. This drawing is subject to change without notice.
- C.
- 2 place decimals are ±0.030 (±0,76mm). 3 place decimals are ±0.010 (±0,25mm). D.
- E. Recommended keep out area for user components.
- F. Power pin connection should utilize two or more vias
- to the interior power plane of 0.025 (0,63) I.D. per input, ground and output pin (or the electrical equivalent).
- Paste screen opening: 0.080 (2,03) to 0.085 (2,16). G. Paste screen thickness: 0.006 (0,15).
- H. Pad type: Solder mask defined.
- I. All pins: Material Copper Alloy
 - Finish Tin (100%) over Nickel plate Solder Ball See product data sheet.
- J. Dimension prior to reflow solder.



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